

Formula 7 Nano Diamond Thermal Compound

PRODUCT WEB PAGE: http://www.antec.com/Believe it/product1.php?id=MjU00Q==



Product Name	Formula 7 Nano Diamond Thermal Compound
Replaces	N/A
Street Price	\$14.99
Certifications/Safety	RoHS
Product Warranty	AQ3
Unit Dimensions	75 mm (H) x 27 mm (W) 17 mm (D) 3" (H) x 1.1" (W) x 0.7" (D)
Unit UPC	0761345-77061-3
Packaging Type	Box
Packaging Dimensions	170 mm (H) x 67 mm (W) x 22 mm (D) 6.7" (H) x 2.6" (W) x 0.9" (D)
Net Weight	1 oz
Gross Weight (packaged)	0.5 lbs

25-CHARACTER DESCRIPTION:

A diamond-caliber solution

50-WORD DESCRIPTION:

Antec's Formula 7 thermal compound helps keep your CPU cool even when your rig is running on all cylinders. Composed to perform optimally between extreme temperatures of -50°C to 250°C, Formula 7's diamond particles facilitate the transfer of heat between your CPU and heat sink, thus increasing your system's efficiency.

100-WORD DESCRIPTION:

Antec's Formula 7 thermal compound protects your CPU even when your rig is running on all cylinders. Since little of the CPU's surface actually touches the heat sink, you need a solution that isolates and facilitates the transfer of heat. Formula 7's nano diamond particles minimize the distance between heat-conductive compounds and gladly take on an overclocking environment, optimally performing between -50°C and 250°C. To keep your system cool and your CPU functioning comfortably, pick up Antec's Formula 7 for a diamond-caliber solution.

150-WORD DESCRIPTION:

Antec's Formula 7 nano diamond thermal compound protects your CPU even when your rig is running on all cylinders. Since little of the CPU's surface actually touches the heat sink, you need a solution that not only facilitates the transfer of heat, but also prevents heat from escaping. Formula 7's nano diamond particles provide a smooth layer that minimizes the distance between heat-conductive compounds—a feat other standard metal-based compounds are not capable of. Such a layer has a diamond concentration that is more than double that of similar products. Formula 7 is the most durable product on the market in that is light and easy enough to apply without cracking or drying out. In addition, it optimally performs between -50°C to 250°C, giving you an irreplaceable, reliable gel that welcomes overclocking. To keep your system cool and your CPU functioning comfortably, pick up Antec's Formula 7 for a diamond-caliber solution.